

L Number	Hits	Search Text	DB	Time stamp
2	382	257/707.ccls. and (@ad<19980903)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 16:45
3	130	(257/707.ccls. and (@ad<19980903)) and (ball or balls or bump or bumps)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 16:48
4	41	((257/707.ccls. and (@ad<19980903)) and (ball or balls or bump or bumps)) and (underfill or encapsulant or encpasulate)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 16:50
5	176	((((chip or die) and fin\$1) with (sink or spreader)) and (@ad<19980903) and (ball or balls or bump or bumps)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 16:50
6	48	((((chip or die) and fin\$1) with (sink or spreader)) and (@ad<19980903) and (ball or balls or bump or bumps)) and (underfill or encapsulant or encpasulate)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 16:50
7	42	(((((chip or die) and fin\$1) with (sink or spreader)) and (@ad<19980903) and (ball or balls or bump or bumps)) and (underfill or encapsulant or encpasulate)) not ((257/707.ccls. and (@ad<19980903)) and (ball or balls or bump or bumps)) and (underfill or encapsulant or encpasulate))	USPAT	2004/10/22 17:09
8	1106	((tim or interface or adhesive) near silicone) and (chip or die)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 17:39
9	169	((((tim or interface or adhesive) near silicone) and (chip or die)) and (sink or spreader) and (chip or die)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 17:43
10	9	(((((tim or interface or adhesive) near silicone) and (chip or die)) and (sink or spreader) and (chip or die)) and (gel near elastomer)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 17:46
11	16	(sink or spreade) with (gel near elastomer)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 17:47
12	16	(sink or spreader) with (gel near elastomer)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 17:47